

The 3N190 is a monolithic dual enhancement mode P-Channel Mosfet

The 3N190 is a dual enhancement mode P-Channel Mosfet and is ideal for space constrained applications and those requiring tight electrical matching.

The hermetically sealed TO-78 package is well suited for high reliability and harsh environment applications.

(See Packaging Information).

3N190 Features:

- Very high Input Impedance
- High Gate Breakdown Voltage
- Low Capacitance

FEATURES

DIRECT REPLACEMENT FOR INTERSIL 3N190

LOW GATE LEAKAGE CURRENT $I_{GSS} \leq \pm 10\text{pA}$

LOW TRANSFER CAPACITANCE $C_{RSS} \leq 1.0\text{pF}$

ABSOLUTE MAXIMUM RATINGS¹ @ 25°C (unless otherwise noted)

Maximum Temperatures

Storage Temperature -65°C to +150°C

Operating Junction Temperature -55°C to +135°C

Maximum Power Dissipation

Continuous Power Dissipation (one side) 300mW

Continuous Power Dissipation (one side) 525mW

MAXIMUM CURRENT

Drain to Source² 50mA

MAXIMUM VOLTAGES

Drain to Gate or Drain to Source² -30V

Transient Gate to Source^{2,3} $\pm 125\text{V}$

Gate-Gate Voltage $\pm 80\text{V}$

3N190 ELECTRICAL CHARACTERISTICS @ 25°C (unless otherwise noted)

SYMBOL	CHARACTERISTIC	MIN	TYP.	MAX	UNITS	CONDITIONS
BV_{DSS}	Drain to Source Breakdown Voltage	-40	--	--	V	$I_D = -10\mu\text{A}$
BV_{SDS}	Source to Drain Breakdown Voltage	-40	--	--		$I_S = -10\mu\text{A}, V_{BD} = 0\text{V}$
V_{GS}	Gate to Source Voltage	-3.0	--	-6.5		$V_{DS} = -15\text{V}, I_D = -500\mu\text{A}$
$V_{GS(th)}$	Gate to Source Threshold Voltage	-2.0	--	-5.0		$V_{DS} = -15\text{V}, I_D = -500\mu\text{A}$
		-2.0	--	-5.0		$V_{DS} = V_{GS}, I_D = -10\mu\text{A}$
I_{GSSR}	Gate Reverse Leakage Current	--	--	10	pA	$V_{GS} = 40\text{V}$
I_{GSSF}	Forward Gate Leakage Current	--	--	-10		$V_{GS} = -40\text{V}$
I_{DSS}	Drain to Source Leakage Current	--	--	-200		$V_{DS} = -15\text{V}$
I_{SDS}	Source to Drain Leakage Current	--	--	-400		$V_{SD} = -15\text{V}, V_{DB} = 0$
$I_{D(on)}$	Drain Current "On"	-5.0	--	-30	mA	$V_{DS} = -15\text{V}, V_{GS} = -10\text{V}$
$r_{DS(on)}$	Drain to Source "On" Resistance	--	--	300	Ω	$V_{DS} = -20\text{V}, I_D = -100\mu\text{A}$
g_{fs}	Forward Transconductance ⁴	1500	--	4000	μS	$V_{DS} = -15\text{V}, I_D = -5\text{mA}, f = 1\text{kHz}$
Y_{os}	Output Admittance	--	--	300	pF	$V_{DS} = -15\text{V}, I_D = -5\text{mA}, f = 1\text{MHz}$
C_{iss}	Input Capacitance	--	--	4.5		
C_{rss}	Reverse Transfer Capacitance	--	--	1.0		
C_{oss}	Output Capacitance	--	--	3.0		

MATCHING CHARACTERISTICS 3N190

SYMBOL	CHARACTERISTIC	LIMITS		UNITS	CONDITIONS
		MIN	MAX		
g_{fs1}/g_{fs2}	Forward Transconductance Ratio	0.85	1.0	ns	$V_{DS} = -15\text{V}, I_D = -500\mu\text{A}, f = \text{kHz}$
V_{GS1-2}	Gate Source Threshold Voltage Differential ⁵	--	100	mV	$V_{DS} = -15\text{V}, I_D = -500\mu\text{A}$
$\Delta V_{GS1-2}/\Delta T$	Gate Source Threshold Voltage Differential Change with Temperature ⁵	--	100	$\mu\text{V}/^\circ\text{C}$	$V_{DS} = -15\text{V}, I_D = -500\mu\text{A}, T_S = -55^\circ\text{C to } +25^\circ\text{C}$ $V_{DS} = -15\text{V}, I_D = -500\mu\text{A}, T_S = +25^\circ\text{C to } +125^\circ\text{C}$

SWITCHING CHARACTERISTICS

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	CONDITIONS
$t_{d(on)}$	Turn On Delay Time	--	--	15	ns	$V_{DD} = -15\text{V}, I_{D(on)} = -5\text{mA}, R_G = R_L = 1.4\text{K}\Omega$
t_r	Turn On Rise Time	--	--	30		
t_{off}	Turn Off Time	--	--	50		

Note 1 - Absolute maximum ratings are limiting values above which 3N190 serviceability may be impaired.

Note 2 - Per Transistor

Note 3 - Approximately doubles for every 10°C in T_A

Note 4 - Measured at end points, T_A and T_B

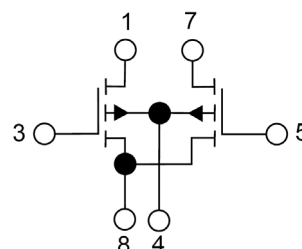
Note 5 - Pulse: $t = 300\mu\text{S}$, Duty Cycle $\leq 3\%$

Available Packages:

3N190 in TO-72
3N190 in bare die.

Please contact Micross for full package and die dimensions

Device Schematic



TO-78 (Bottom View)

